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TOSHIBA Power Transistor Module Silicon NPN Epitaxial Type (Darlington power transistor 4 in 1)

MP4101

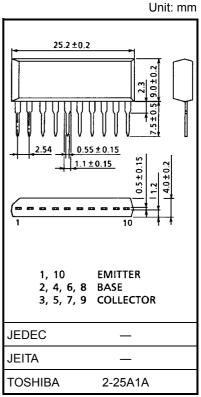
High Power Switching Applications. Hammer Drive, Pulse Motor Drive. Inductive Load Switching.

- Small package by full molding (SIP 10 pin)
- High collector power dissipation (4 devices operation) : $P_T = 4 W (Ta = 25^{\circ}C)$
- High collector current: $I_{C (DC)} = 4 A (max)$
- High DC current gain: $h_{FE} = 2000$ (min) ($V_{CE} = 2$ V, $I_C = 1$ A)
- Zener diode included between collector and base.

Maximum Ratings (Ta = 25°C)

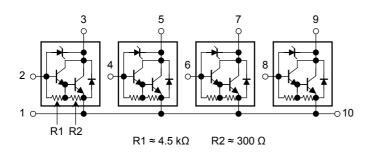
| Characteristics | | Symbol | Rating | Unit | |
|-----------------------------|-------|------------------|------------|------|--|
| Collector-base voltage | | V _{CBO} | 60 ± 10 | V | |
| Collector-emitter voltage | | V _{CEO} | 60 ± 10 | V | |
| Emitter-base voltage | | V _{EBO} | 6 | V | |
| Collector current | DC | Ι _C | 4 | A | |
| | Pulse | I _{CP} | 6 | | |
| Continuous base current | | Ι _Β | 0.5 | А | |
| Collector power dissipation | | Pc | 2.0 | W | |
| (1 device operation) | | | 2.0 | vv | |
| Collector power dissipation | | PT | 4.0 | W | |
| (4 devices operation) | | | 4.0 | | |
| Junction temperature | | Тј | 150 | °C | |
| Storage temperature range | | T _{stg} | -55 to 150 | °C | |





Weight: 2.1 g (typ.)

Array Configuration



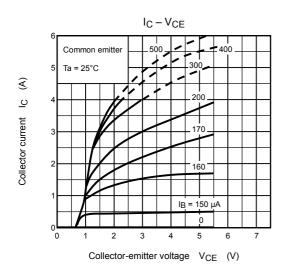
Thermal Characteristics

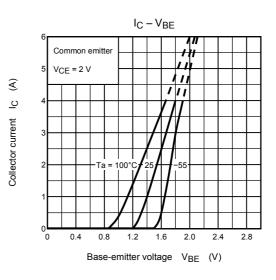
| Characteristics | Symbol | Max | Unit | |
|--|------------------------|------|------|--|
| Thermal resistance of junction to ambient | ΣR _{th (j-a)} | 31.3 | °C/W | |
| (4 devices operation, Ta = 25°C) | | | | |
| Maximum lead temperature for soldering purposes | TL | 260 | °C | |
| (3.2 mm from case for 10 s) | | | | |

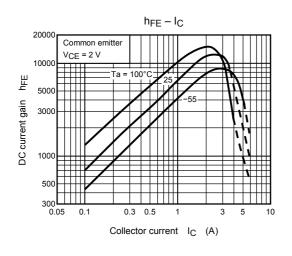
Electrical Characteristics (Ta = 25°C)

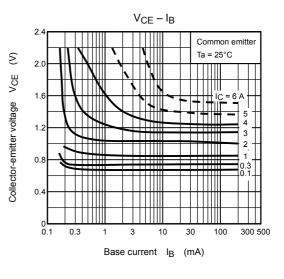
| Charac | teristics | Symbol | Test Condition | Min | Тур. | Max | Unit | |
|-------------------------------------|-------------------|-----------------------|---|------|------|-------|------|--|
| Collector cut-off current | | I _{CBO} | V _{CB} = 45 V, I _E = 0 A | _ | — | 10 | μA | |
| Collector cut-off current | | I _{CEO} | V _{CE} = 45 V, I _B = 0 A | _ | — | 10 | μA | |
| Emitter cut-off current | | I _{EBO} | V _{EB} = 6 V, I _C = 0 A | 0.6 | | 20 | mA | |
| Collector-base breakdown voltage | | V (BR) CBO | I _C = 10 mA, I _E = 0 A | 50 | 60 | 70 | V | |
| Collector-emitter breakdown voltage | | V (BR) CEO | I _C = 10 mA, I _B = 0 A | 50 | 60 | 70 | V | |
| DC current gain | | h _{FE (1)} | V _{CE} = 2 V, I _C = 1 A | 2000 | | 15000 | | |
| | | h _{FE (2)} | V _{CE} = 2 V, I _C = 3 A | 1000 | _ | _ | | |
| Saturation voltage | Collector-emitter | V _{CE (sat)} | I _C = 3 A, I _B = 10 mA | _ | _ | 1.5 | v | |
| | Base-emitter | V _{BE (sat)} | I _C = 3 A, I _B = 10 mA | _ | _ | 2.0 | | |
| Transition frequency | | f _T | V _{CE} = 2 V, I _C = 0.5 A | _ | 60 | _ | MHz | |
| Collector output capacitance | | C _{ob} | V _{CB} = 10 V, I _E = 0 A, f = 1 MHz | _ | 30 | _ | pF | |
| Switching time S | Turn-on time | t _{on} | $20 \ \mu s$ m M H_{B1} m H_{B2} M H_{B2} M V_{CC} = 30 V H_{B1} = -H _{B2} = 10 mA, duty cycle ≤ 1% | _ | 0.2 | _ | | |
| | Storage time | t _{stg} | | _ | 3.0 | _ | μs | |
| | Fall time | t _f | | _ | 0.5 | _ | | |

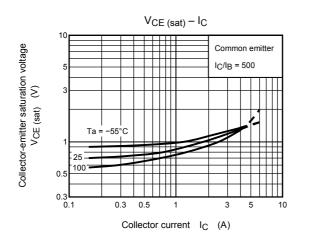
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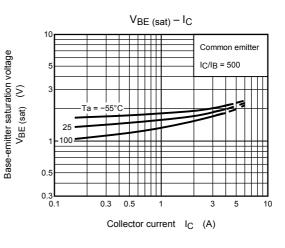


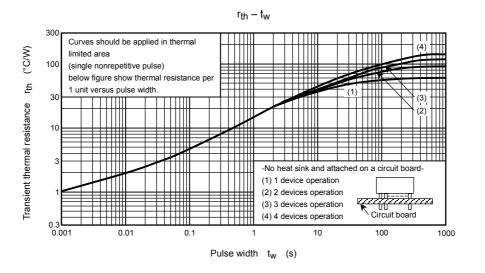


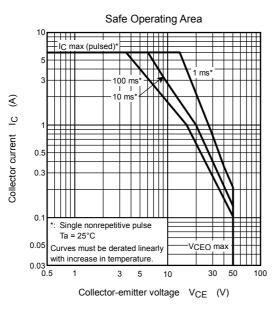


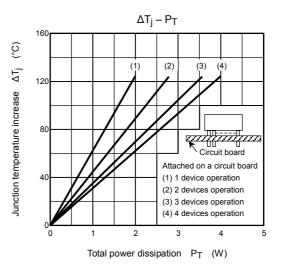


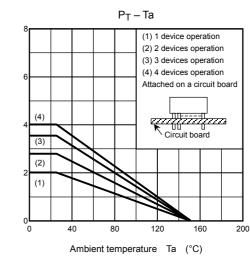












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Total power dissipation

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